

austriamicrosystems AG  
A 8141 Schloss Premstätten, Austria

T. +43 (0) 3136 500-5447  
F. +43 (0) 3136 525-01  
Udo.Theissl@austriamicrosystems.com  
www.austriamicrosystems.com

Unterpremstätten, June 2007

**Product Change Notification Number: 03 - 2007**  
**Change of procedures for internal visual test methods**

Dear Customer,

Please be informed, that austriamicrosystems AG will change the procedure for optical inspection at

- Fab out (optical inspection of wafers)
- Backend (optical inspection of tested wafers, dice on foil)

from a manual microscope inspection to an automated visual inspection performed by a high end fully automated inspection tool.

**Products affected:**

all

**Change purpose:**

As part of our continuous improvement process and as integrated part of our "Zero Defects program" we are steady working on enhanced quality inspections to detect any abnormality on our material and to guarantee fast and efficient feedback to our production line.

The cooperation with the market leader in the field of automated visual inspection "*Rudolph Technologies*" and the use of high end tools guarantees highest security in this field.

It enables us to replace any other manual inspection for fab and backend related defects with highest reliability.

**Risk Assessment:**

No risk

Timing of change (planned for your product): September 2007

**Measurement qualification tests:**

Run attribute gage R&R study

**Impact on Product:**

No impact on products

Enhance Quality level at optical inspection

Please be advised that unless we receive your written refusal concerning this PCN within 30 days, the PCN shall be deemed accepted.

For further information please feel free to contact me.

Best regards,

austriamicrosystems AG

A handwritten signature in black ink, appearing to read 'Theißl Udo', written in a cursive style.

Udo Theißl

Manager Quality Control